



1-Line Unidirectional ESD Protection Diode

General description

Unidirectional ElectroStatic Discharge (ESD) protection diode in a SOD523 plastic package designed to protect one transmission or data line from the damage caused by ESD and other transients

Features and benefits

- . Unidirectional ESD protection of one line
- . Reverse stand-off voltage: 24V Max
- . Low leakage current: nA Level
- . Response time is typically < 1 ns
- . Low clamping voltage: $V_C < 55 V @ I_{PP} = 6 A$
- . ESD Protection: 20kV(air)/ 15kV(contact) (IEC61000-4-2)
- . Surge Protection: 6 A (IEC 61000-4-5 8/20 μs)

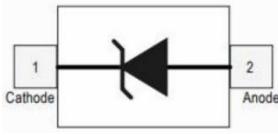
Application information

- . Computers and peripherals
- . Communication systems
- . Audio equipment
- . CAN bus protection
- . Power supplies

Ordering information

Device	Package	Marking	Packaging
ESD5Z24	SOD523	N5	3000/Tape & Reel

Schematic & Pin configuration

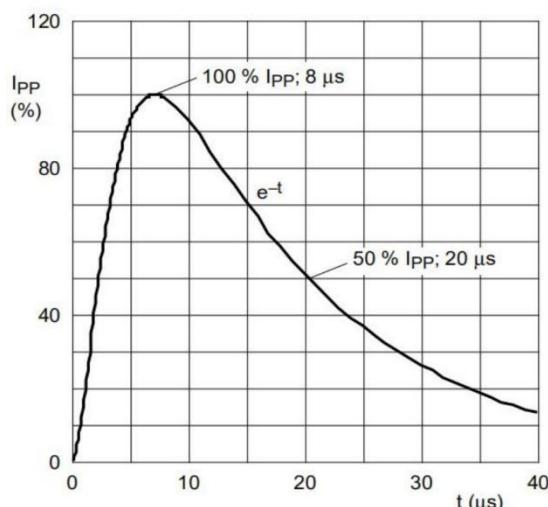
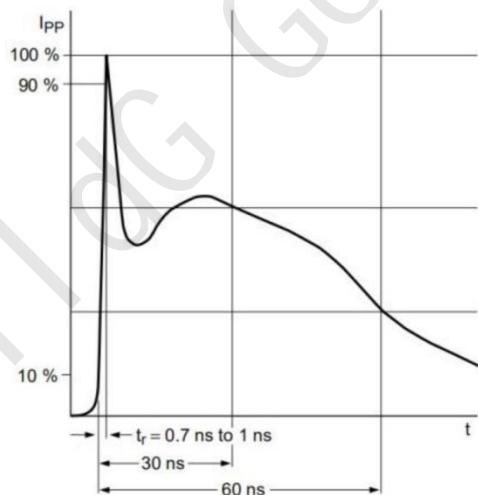
Simplified outline	Graphic symbol
	

Maximum Ratings ($T_{OP} = 25^\circ C$, unless otherwise specified)

Parameter	Symbol	Value	Unit
Peak Pulse Power ($tp = 8/20 \mu s$)	P_{PPM}	330	W
Peak Pulse Current($tp = 8/20 \mu s$)	I_{PPM}	6	A
Maximum lead temperature for soldering during 10s	T_L	260	°C
Storage Temperature Range	T_{stg}	-55 to +150	°C
Operating Temperature Range	T_{OP}	-40 to +125	°C
Maximum junction temperature	T_j	150	°C
ESD voltage IEC 61000-4-2 (air discharge)	V_{ESD}	20	kV
ESD voltage IEC 61000-4-2 (contact discharge)	V_{ESD}	15	kV

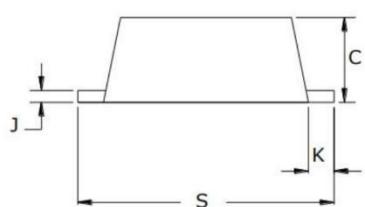
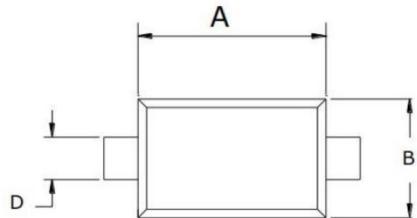
Electrical Characteristics ($T_{OP} = 25^\circ C$, unless otherwise specified)

Parameter	Symbol	Min	Typ	Max	Unit	Condition
Reverse Working Voltage	V_{RWM}	--	--	24.0	V	
Breakdown Voltage	V_{BR}	26.0	--	--	V	$I=1mA$
Leakage Current I_{Leak}	I_R	--	--	100	nA	$V_{RWM}=24V$
Clamping Voltage	V_C	--	--	55.0	V	$I_{PP}=6A, Tp=8/20\mu s$
Junction Capacitance	C_J	--	25	30	pF	$V_R=0V, f=1MHz$

Typical Electrical and Thermal Characteristics (Curves)


Package Outline Dimensions

SOD523



SYMBOL	MILLIMETERS		
	MIN	NOR	MAX
A	1.10	1.20	1.30
B	0.70	0.80	0.90
C	0.60	0.65	0.70
D	0.25	0.30	0.35
J	0.08	0.11	0.15
K	0.15	0.20	0.25
S	1.50	1.60	1.70

Soldering Footprint (mm)

